

## Features

- Uses advanced SGT technology
- Extremely low on-resistance  $R_{DS(on)}$
- Excellent gate charge x  $R_{DS(on)}$  product(FOM)

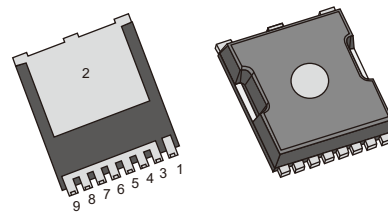
Product Summary			
$V_{DS}$	$R_{DS(on)}$ (m $\Omega$ ) Typ	$I_D$ (A)	$Q_g$ (Typ)
60V	1.3 @ 10V 20A	275	115nc

## Mechanical Data

- Case:TOLL Package

TOLL

D013N06T



## Application

- Motor control and drives
- Battery management
- DC/DC converter
- General purpose applications

## Ordering Information

Part No.	Package Type	Package	Quality(box)
D013N06T	TOLL	Tape & Reel	2000

## Block Diagram

Pin Definition:

1. Gate  
2. Drain  
3/4/5/6/7/8/9. Source

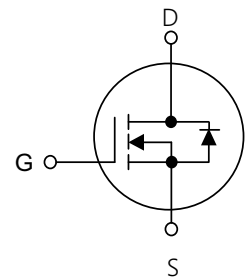


Table1 Absolute Maximum Ratings ( $T_C=25^\circ\text{C}$ , unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	60	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current	$I_D$	$T_C=25^\circ\text{C}$	A
		$T_C=100^\circ\text{C}$	
Pulsed Drain Current (Note 1)	$I_{DM}$	936	A
Single Pulse Avalanche Energy(Note 2)	$E_{AS}$	248	mJ
Power Dissipation $T_C=25^\circ\text{C}$	$P_D$	231	W
Operating Junction and Storage Temperature	$T_J/T_{STG}$	-55~+150	$^\circ\text{C}$

Table 2. Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal resistance Junction to Ambient	$R_{\theta JA}$	60	$^{\circ}\text{C}/\text{W}$
Thermal resistance Junction to Case	$R_{\theta JC}$	0.54	$^{\circ}\text{C}/\text{W}$

Table 3. Electrical Characteristics ( $T_J=25^{\circ}\text{C}$ , unless otherwise specified)

Parameter		Symbol	Test Conditions	Min	Typ	Max	Unit
Off Characteristics							
Drain-Source Breakdown Voltage		BV <sub>DSS</sub>	V <sub>GS</sub> =0V,I <sub>D</sub> =250μA	60	-	-	V
Drain-Source Leakage Current		I <sub>DSS</sub>	V <sub>D</sub> S=60V,V <sub>GS</sub> =0V	-	-	1	μA
Gate- Source Leakage Current	Forward	I <sub>GSS</sub>	V <sub>GS</sub> =20V,V <sub>D</sub> S=0V	-	-	100	nA
	Reverse		V <sub>GS</sub> =-20V,V <sub>D</sub> S=0V	-	-	-100	nA
On Characteristics(Note 3)							
Gate Threshold Voltage		V <sub>GS(TH)</sub>	V <sub>D</sub> S=V <sub>GS</sub> ,I <sub>D</sub> =250μA	1.2	-	2.5	V
Static Drain-Source On-State Resistance		R <sub>D</sub> S(ON)	V <sub>GS</sub> =10V,I <sub>D</sub> =20A	-	1.3	1.6	mΩ
Dynamic Characteristics(Note 4)							
Input Capacitance		C <sub>ISS</sub>	V <sub>D</sub> S=30V,V <sub>GS</sub> =0V,f=300KHz	-	7192	-	pF
Output Capacitance		C <sub>OSS</sub>		-	1647	-	pF
Reverse Transfer Capacitance		C <sub>RSS</sub>		-	44	-	pF
Gate Resitance		R <sub>G</sub>	V <sub>DD</sub> =0V,V <sub>GS</sub> =0V,f=1MHz	-	0.9	-	Ω
Switching Characteristics (Note 4)							
Turn-On Delay Time		t <sub>d(on)</sub>	V <sub>DD</sub> =26V,I <sub>D</sub> =16.25A V <sub>GS</sub> =13V,R <sub>L</sub> =2.2Ω,	-	0.6	-	ns
Turn-On Rise Time		t <sub>r</sub>		-	21.8	-	ns
Turn-Off Delay Time		t <sub>d(off)</sub>		-	67.6	-	ns
Turn-Off Fall Time		t <sub>f</sub>		-	6.6	-	ns
Total Gate Charge		Q <sub>G</sub>	V <sub>D</sub> S=30V,I <sub>D</sub> =50A, V <sub>GS</sub> =10V	-	115	-	nC
Gate-Source Charge		Q <sub>GS</sub>		-	28	-	nC
Gate-Drain Charge		Q <sub>GD</sub>		-	16	-	nC
Drain-Source Diode Characteristics and Maximum Ratings							
Drain-Source Diode Forward Voltage		V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =20A	-	0.77	1.2	V
Maximum Continuous Drain-Source Diode Forward Current		I <sub>S</sub>		-	-	234	A
Reverse Recovery Time		t <sub>rr</sub>	V <sub>GS</sub> =0V, I <sub>F</sub> =1A dI <sub>F</sub> /dt= 100A/μs	-	98	-	ns
Reverse Recovery Charge		Q <sub>RR</sub>		-	310	-	nC

Notes : 1 Repetitive Rating:Pulse width limited by maximum junction temperature

2  $L=0.5mH, V_{DS}=48V$ , Starting  $T_J=25^{\circ}\text{C}$ 

3 Pulse Test: Pulse width  $\leq 300\mu s$ , Duty cycle  $\leq 2\%$ 

4 Guaranteed by design, not subject to production

## Typical Characteristics Diagrams

Figure 1. Output Characteristics

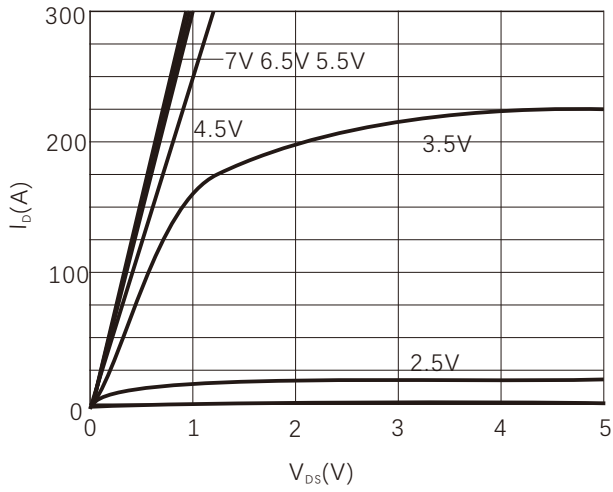


Figure 2. Normalized  $R_{DS(ON)}$  vs Temperature

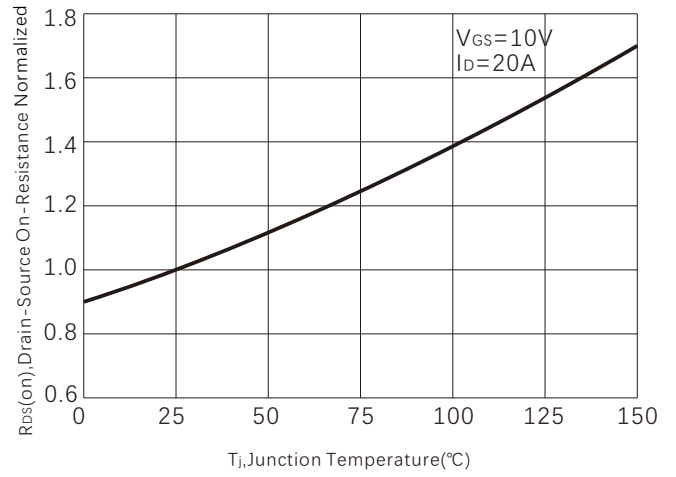


Figure 3. On-Resistance vs. Drain Current

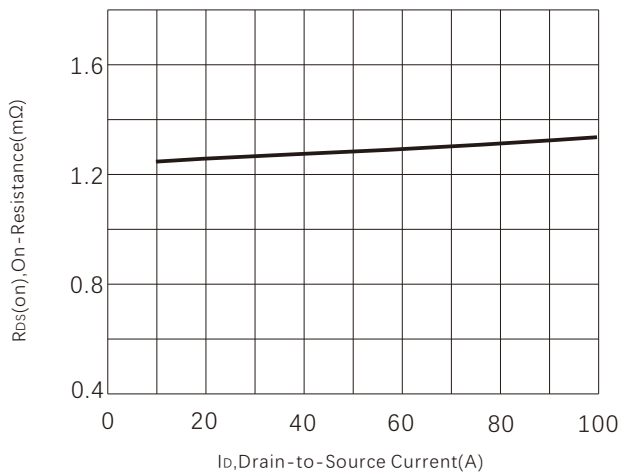


Figure 4. Capacitance

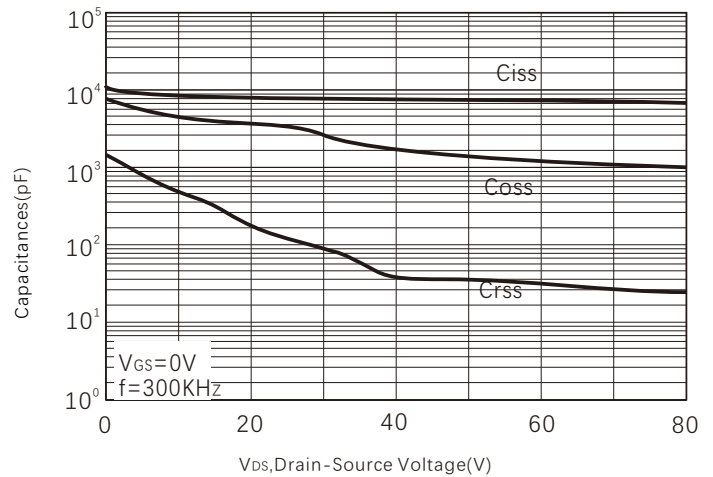


Figure 5. Gate charge

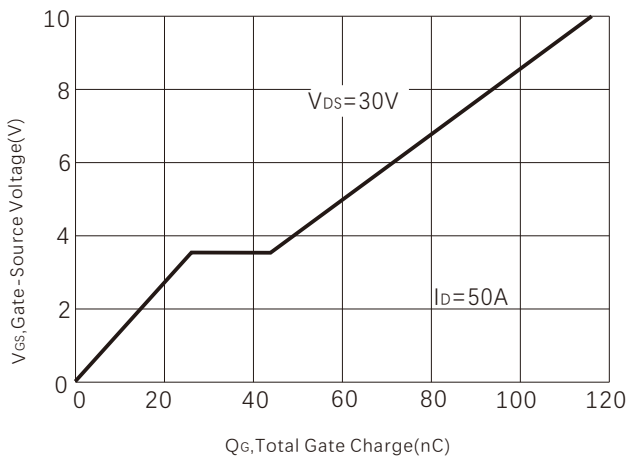


Figure 6. Source-Drain Diode Forward Voltage

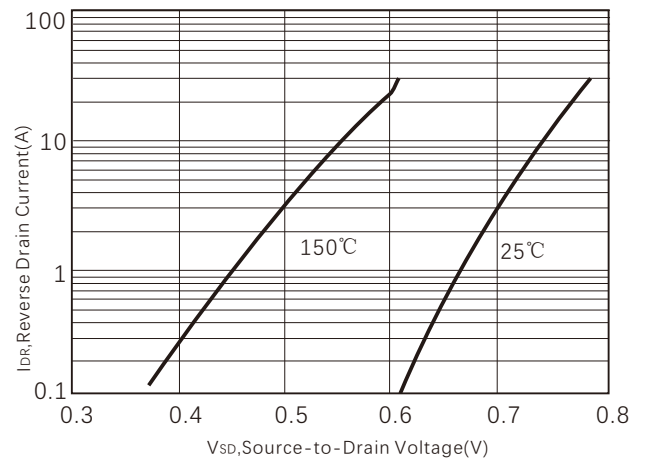


Figure7.Maximum Drain Current vs Temperature

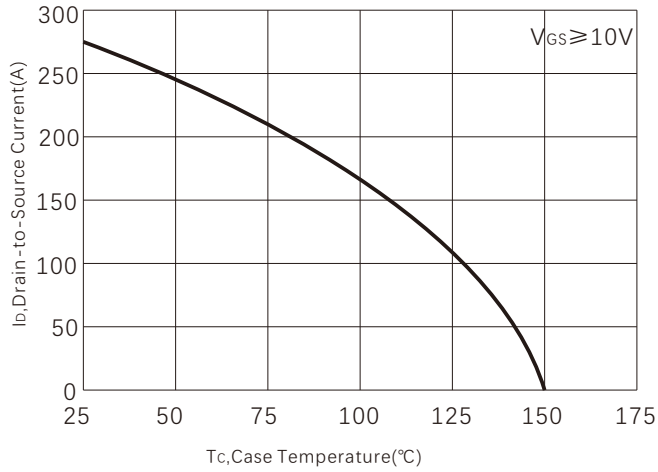


Figure 8. Transfer Characteristics

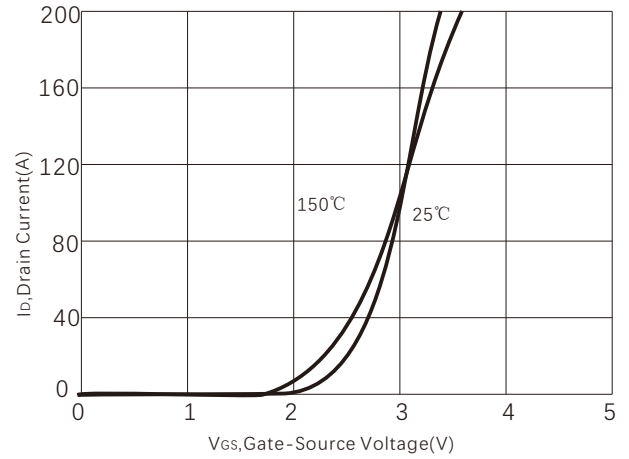


Figure 9. Safe operating area

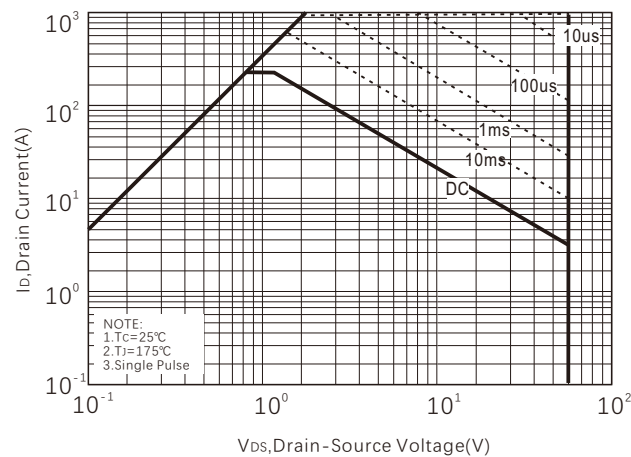
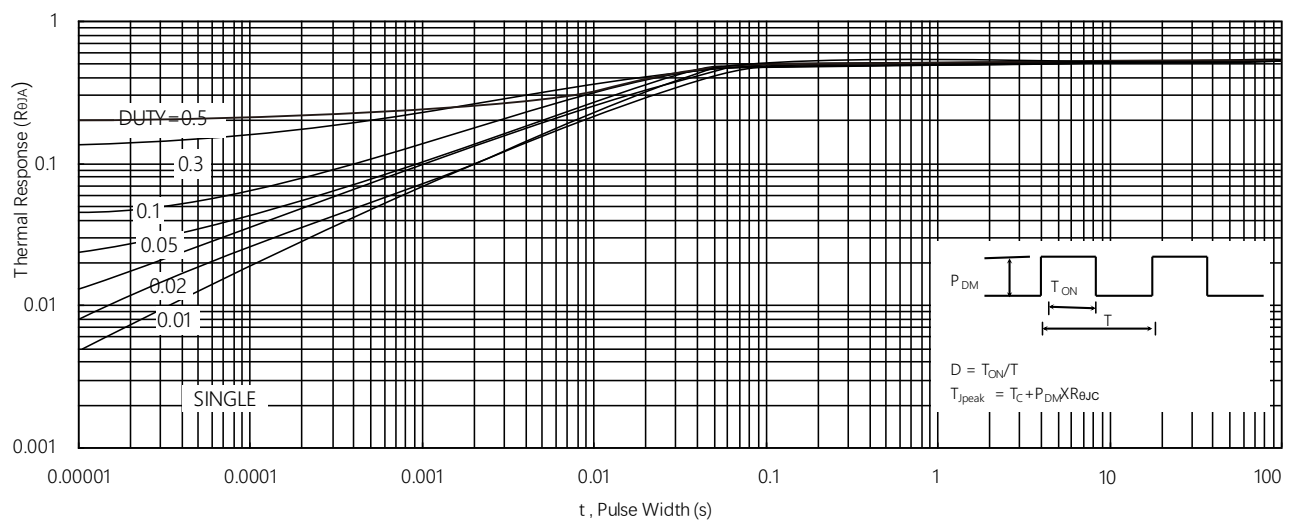
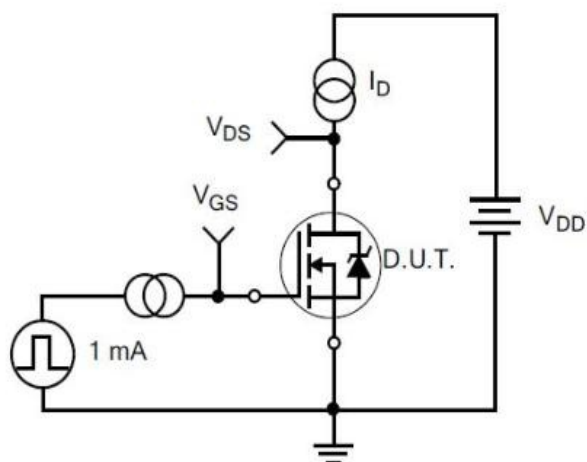


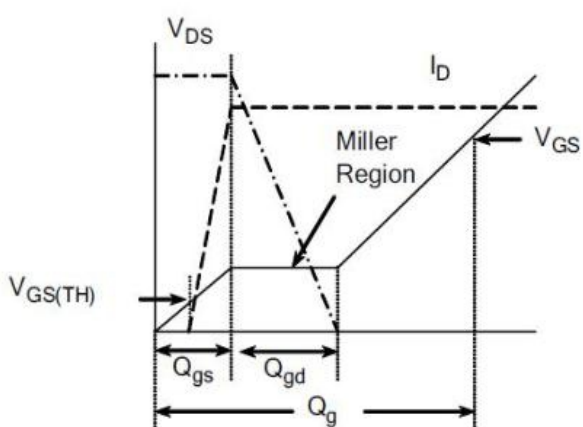
Figure 10. Maximum Transient Thermal Impedance



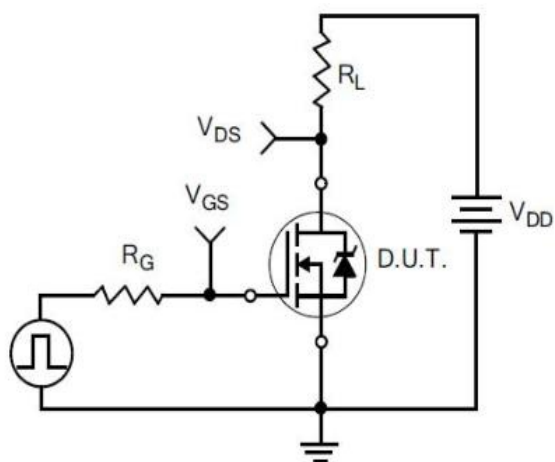
## Typical Test Circuit



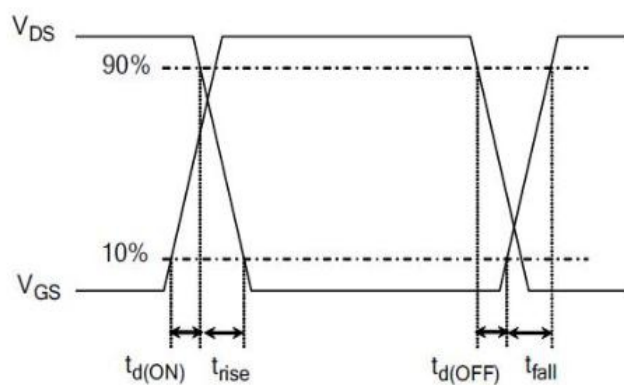
1) Gate Charge Test Circuit



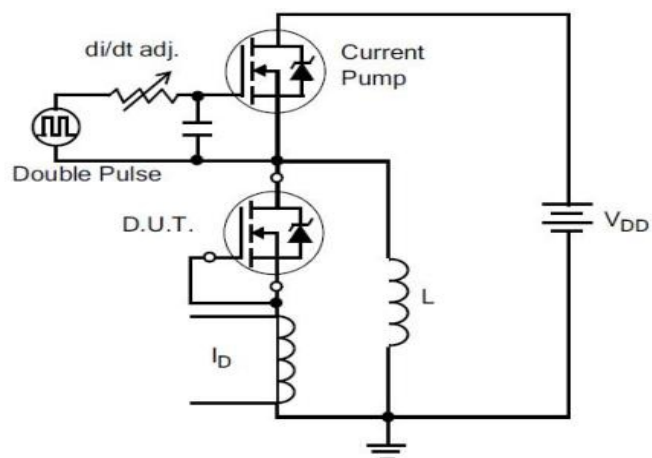
2) . Gate Charge Waveform



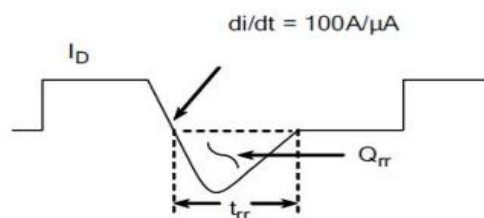
3) Resistive Switching Test Circuit



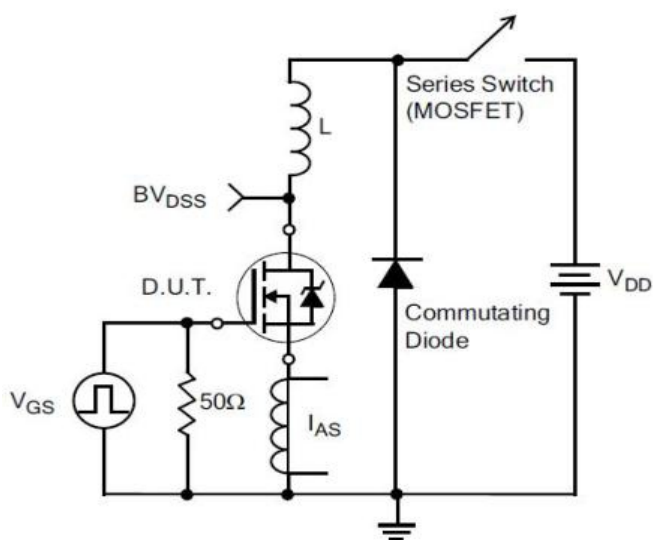
4) Resistive Switching Waveforms



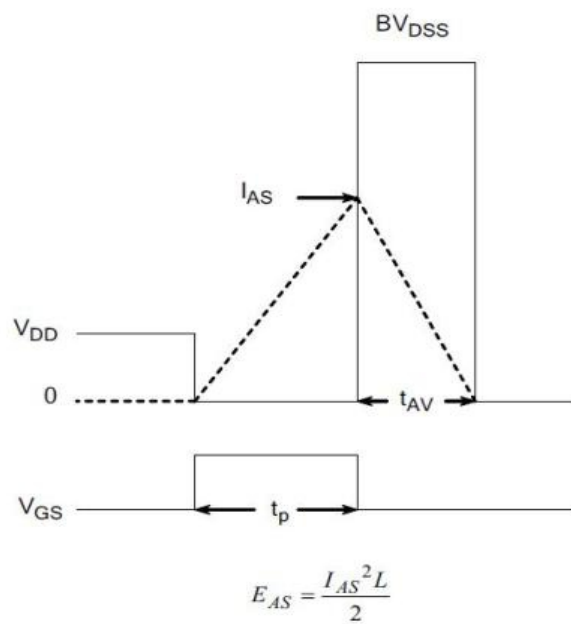
5) Diode Reverse Recovery Test Circuit



6) Diode Reverse Recovery Waveform



7) . Unclamped Inductive Switching Test Circuit



8) Unclamped Inductive Switching Waveforms

# Product Names Rules

X X X N E X X X-X X X

Process Type:  
VDMOS:default  
Super junction:SJ  
Low Voltage trench:D

Rdson Code  
2 Ω :2D0  
9.5m Ω :9M5

Rated Current Code  
With 1-2 Digital,  
For Ex ample:  
4A:4,  
10A:10,  
0.8A:08

Package Code  
TO-220:Default  
ITO-220:F  
TO-262:E  
TO-263:D  
TO-252:M  
TO-251:N  
TO-263-7L:D7  
TOLL:T

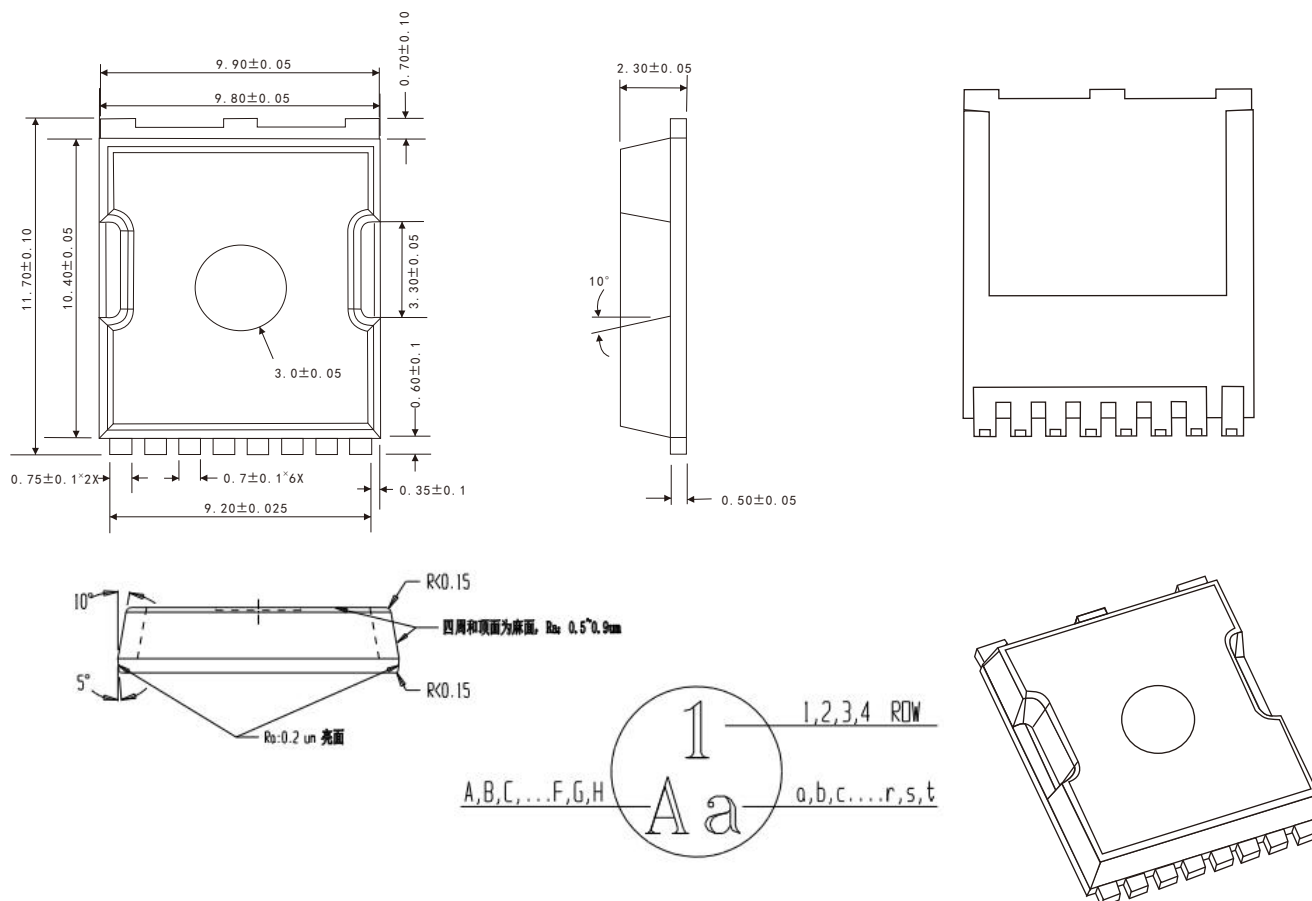
Channel Code  
N channel:N  
P channel:P

Rated Voltage Code  
With 2 Digital,For Example:  
600V:60  
60V:06

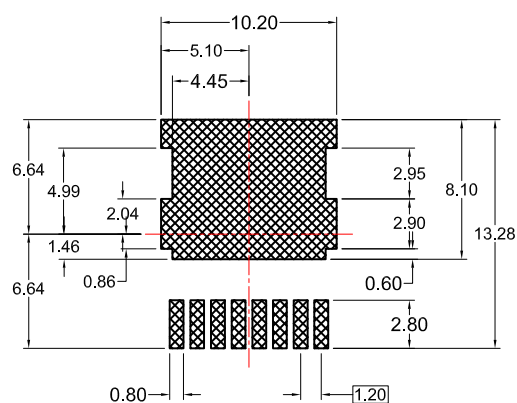
Special Function Code  
G-S ESD Protection:E  
No Protection:Default

# Dimensions

## TOLL PACKAGE OUTLINE DIMENSIONS



## Suggested Pad Layout



## Friendship Reminder

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